

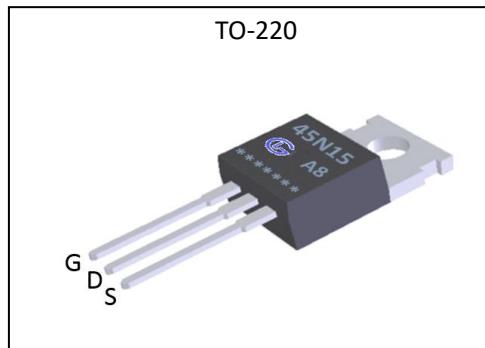
### General Description:

The GL45N15A8 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. The package form is TO-220, which accords with the RoHS standard.

$V_{DSS}$	150	V
$I_D$	45	A
$P_D$	140	W
$R_{DS(ON)}\text{type}$	24	$\text{m}\Omega$

### Features:

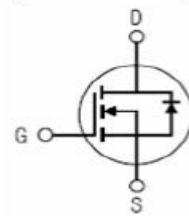
- $R_{DS(ON)} < 28\text{m}\Omega$  @  $V_{GS}=10\text{V}$  (Typ24mΩ)
- High density cell design for ultra low  $R_{ds(on)}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation



### Applications:

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

Inner Equivalent Principium Chart



### Absolute (T<sub>c</sub>= 25°C unless otherwise specified):

Symbol	Parameter	Rating	Units
$V_{DSS}$	Drain-to-Source Voltage	150	V
$I_D$	Continuous Drain Current	45	A
$I_{DM}$	Pulsed Drain Current	180	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$P_D$	Power Dissipation	140	W
$E_{AS}$	Single pulse avalanche energy <sup>a5</sup>	200	mJ
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	175, -55 to 175	°C



# GL45N15A8

## GL Silicon N-Channel Power MOSFET

**Electrical Characteristics** ( $T_c = 25^\circ\text{C}$  unless otherwise specified):

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$V_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	150	--	--	V
$I_{DSS}$	Drain to Source Leakage Current	$V_{DS}=150\text{V}, V_{GS}=0\text{V}, T_a=25^\circ\text{C}$	--	--	1.0	$\mu\text{A}$
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+20\text{V}$	--	--	0.1	$\mu\text{A}$
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-20\text{V}$	--	--	-0.1	$\mu\text{A}$

ON Characteristics <sup>a3</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=10\text{V}, I_D=22.5\text{A}$	--	24	28	$\text{m}\Omega$
$V_{GS(\text{TH})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.0	--	4.0	V

Pulse width  $t_p \leq 380\mu\text{s}, \delta \leq 2\%$

Dynamic Characteristics <sup>a4</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$g_{fs}$	Forward Transconductance	$V_{DS}=15\text{V}, I_D=22.5\text{A}$	13	--	--	S
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=25\text{V}$	--	1310	--	pF
$C_{oss}$	Output Capacitance	$f=1.0\text{MHz}$	--	165	--	
$C_{rss}$	Reverse Transfer Capacitance		--	12	--	

Resistive Switching Characteristics <sup>a4</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=75\text{V}, I_D=2\text{A}, R_L=7\Omega$	--	10	--	ns
$t_r$	Rise Time		--	6	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	15	--	
$t_f$	Fall Time		--	7	--	
$Q_g$	Total Gate Charge	$V_{DD}=75\text{V}, I_D=22.5\text{A}$	--	22	--	nC
$Q_{gs}$	Gate to Source Charge		--	8.5	--	
$Q_{gd}$	Gate to Drain ( "Miller" )Charge		--	5	--	

**Source-Drain Diode Characteristics**

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I <sub>S</sub>	Continuous Source Current <sup>a2</sup> (Body Diode)		--	--	45	A
V <sub>SD</sub>	Diode Forward Voltage <sup>a3</sup>	I <sub>S</sub> =45A, V <sub>GS</sub> =0V	--	--	1.2	V

Symbol	Parameter	Typ.	Units
R <sub>θJC</sub>	Junction-to-Case <sup>a2</sup>	1.07	°C/W

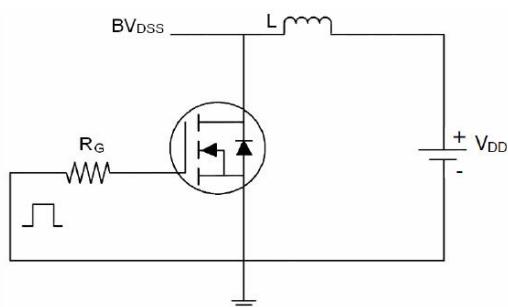
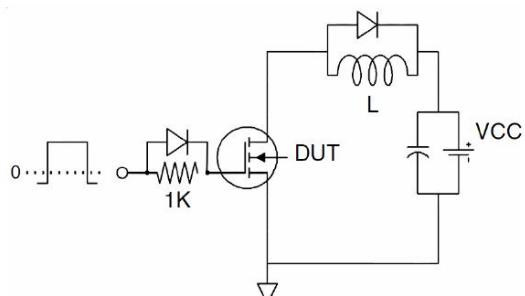
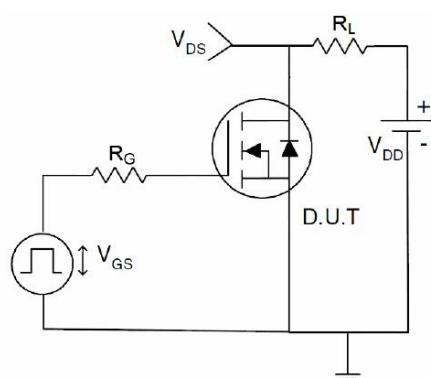
<sup>a1</sup>: Repetitive Rating: Pulse width limited by maximum junction temperature.

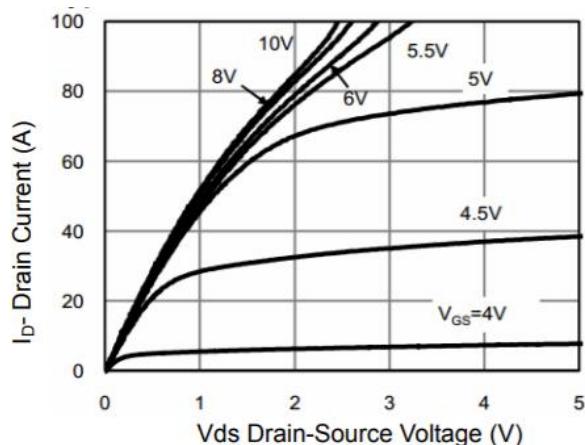
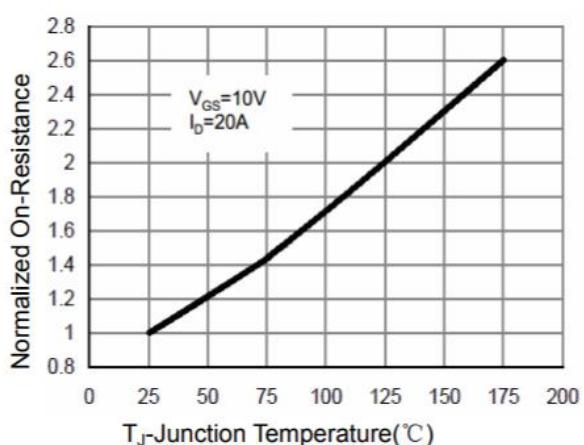
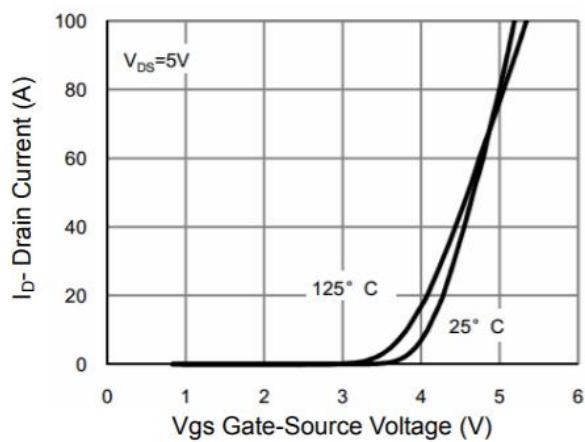
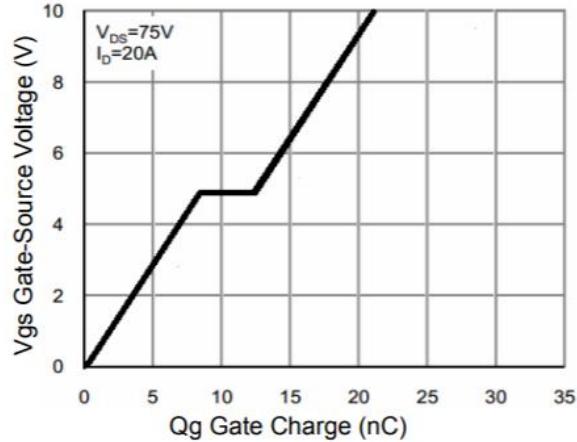
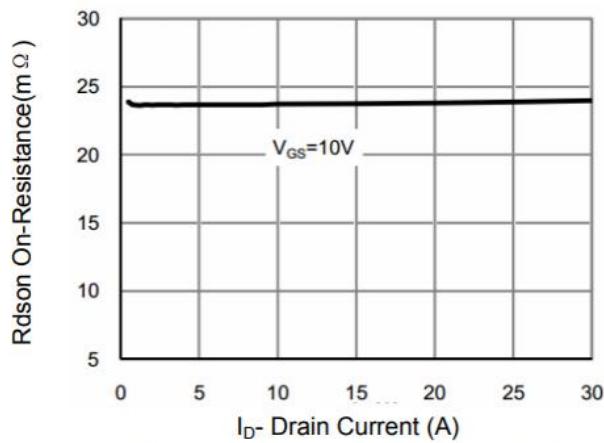
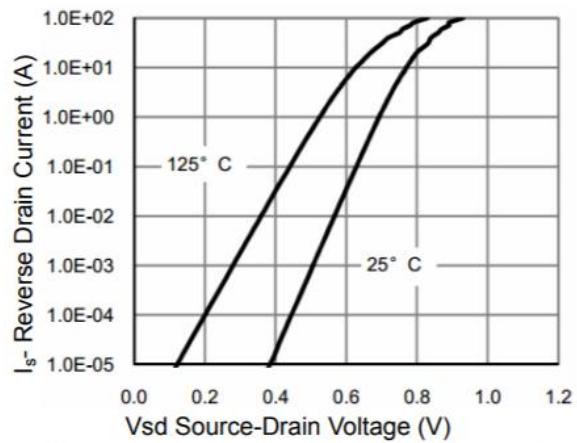
<sup>a2</sup>: Surface Mounted on FR4 Board, t≤10sec.

<sup>a3</sup>: Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%.

<sup>a4</sup>: Guaranteed by design, not subject to production

<sup>a5</sup>: EAS condition: T<sub>j</sub>=25°C, V<sub>DD</sub>=50V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω

**Test circuit**
**1) EAS test Circuit**

**2) Gate charge test Circuit**

**3) Switch Time Test Circuit**


**Characteristics Curve:**

**Figure 1 Output Characteristics**

**Figure 4 Rdson-Junction Temperature**

**Figure 2 Transfer Characteristics**

**Figure 5 Gate Charge**

**Figure 3 Rdson- Drain Current**

**Figure 6 Source- Drain Diode Forward**



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# GL45N15A8

## GL Silicon N-Channel Power MOSFET

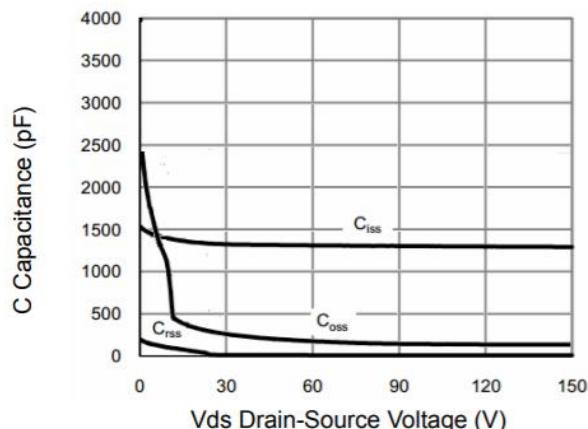


Figure 7 Capacitance vs Vds

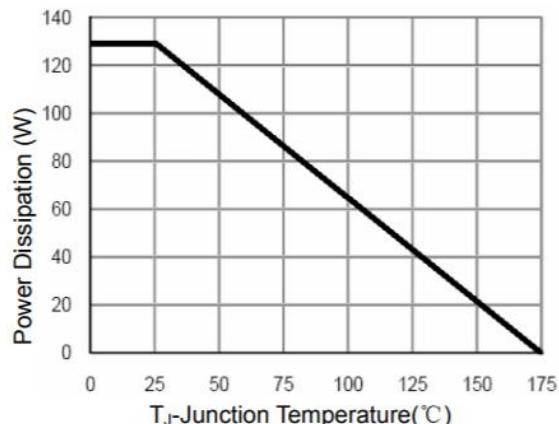


Figure 9 Power De-rating

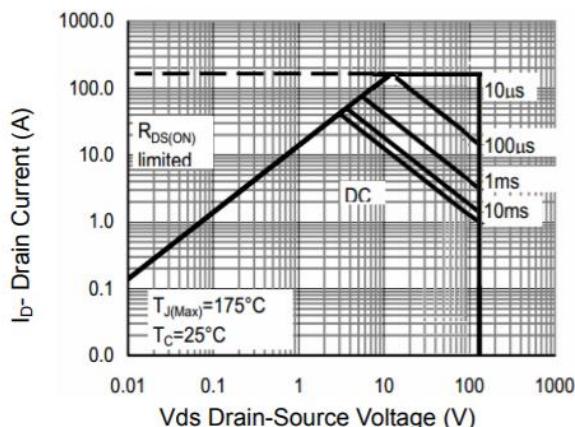


Figure 8 Safe Operation Area

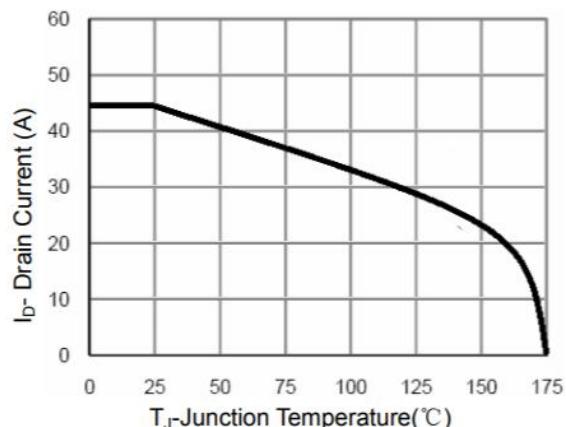


Figure 10 Current De-rating

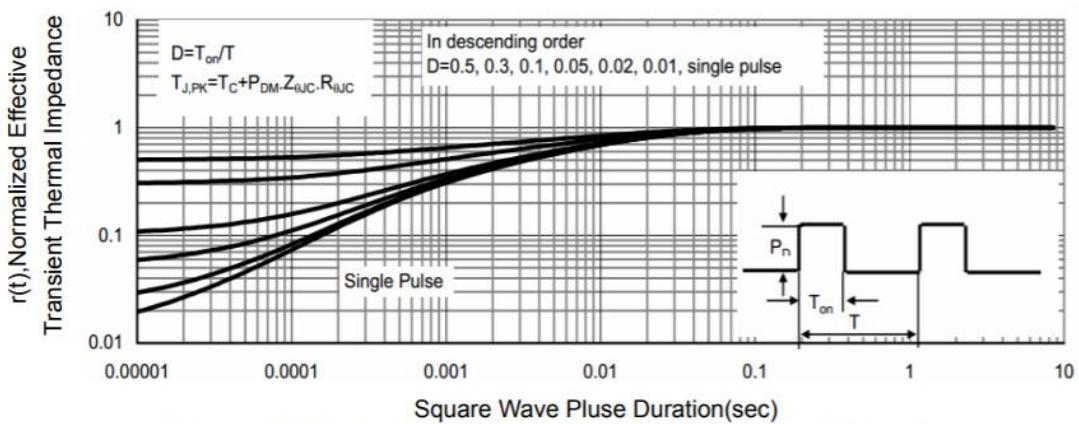


Figure 11 Normalized Maximum Transient Thermal Impedance